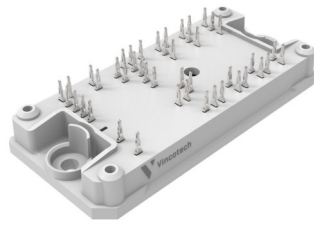
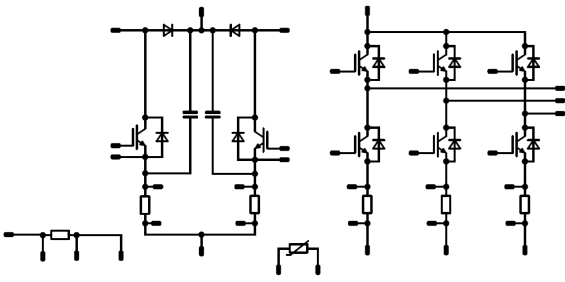




Vincotech

<i>flowPIM 1 + PFC</i>	600 V / 50 A
<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;">Features</div> <ul style="list-style-type: none"> Highly integrated PIM with interleaved PFC circuit High switching frequency PFC circuit On-board capacitors New generation high speed IGBTs in the inverter Emitter shunts 	<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;">flow 1 12 mm housing</div> 
<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;">Target applications</div> <ul style="list-style-type: none"> Embedded Drives Industrial Drives 	<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;">Schematic</div> 
<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;">Types</div> <ul style="list-style-type: none"> 10-PG06PPA050SJ01-LH54E08T 	

Maximum Ratings

$T_j = 25\text{ }^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		600	V
Collector current	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ }^\circ\text{C}$	48	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	150	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ }^\circ\text{C}$	81	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$ $V_{CC} = 400\text{ V}$ $T_j = 150\text{ }^\circ\text{C}$	5	μs
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$



Vincotech

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Inverter Diode				
Peak repetitive reverse voltage	V_{RRM}		600	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	35	A
Repetitive peak forward current	I_{FRM}		60	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	58	W
Maximum junction temperature	T_{jmax}		175	°C
PFC Switch				
Collector-emitter voltage	V_{CES}		650	V
Collector current	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	47	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	150	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	81	W
Gate-emitter voltage	V_{GES}		±20	V
Maximum junction temperature	T_{jmax}		175	°C
PFC Diode				
Peak repetitive reverse voltage	V_{RRM}		650	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	49	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	84	W
Maximum junction temperature	T_{jmax}		175	°C
PFC Sw. Protection Diode				
Peak repetitive reverse voltage	V_{RRM}		650	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	14	A
Repetitive peak forward current	I_{FRM}		20	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	33	W
Maximum junction temperature	T_{jmax}		175	°C
Shunt				
Max DC current	I_{MAX}	$T_c = 25\text{ °C}$	63	A
Power dissipation	P_{tot}	$T_c = 70\text{ °C}$	4	W



Vincotech

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
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PFC Shunt

Maximum DC current	I_{MAX}	$T_c = 25\text{ °C}$	32	A
Power dissipation	P_{tot}	$T_c = 70\text{ °C}$	2	W

Inverter Shunt

Maximum DC current	I_{MAX}	$T_c = 25\text{ °C}$	32	A
Power dissipation	P_{tot}	$T_c = 70\text{ °C}$	2	W

Capacitor (PFC)

Maximum DC voltage	V_{MAX}		630	V
Operation Temperature	T_{op}		-55...+150	°C

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{jop}		-40...(T _{jmax} - 25)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
		AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			min. 12,7	mm
Clearance			8,05	mm
Comparative Tracking Index	CTI		> 200	

*100 % tested in production



Vincotech

Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	I_D [A]	T_j [°C]	Min	Typ	Max	

Inverter Switch

Static

Parameter	Symbol	$V_{GE} = V_{CE}$	V_{GS} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max	Unit
Gate-emitter threshold voltage	$V_{GE(th)}$				0,0008	25	4,1	5,1	5,7	V
Collector-emitter saturation voltage	V_{CESat}		15		50	25 125 150		1,48 1,60 1,64	1,8	V
Collector-emitter cut-off current	I_{CES}		0	600		25			2,8	μA
Gate-emitter leakage current	I_{GES}		20	0		25			100	nA
Internal gate resistance	r_g							none		Ω
Input capacitance	C_{ies}							1950		pF
Output capacitance	C_{oes}	$f = 1$ Mhz	0	25		25		83		
Reverse transfer capacitance	C_{res}							67		
Gate charge	Q_g		15	480	50	25		249		nC

Thermal

Parameter	Symbol	$\lambda_{paste} = 3,4$ W/mK (PSX)	V_{GS} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max	Unit
Thermal resistance junction to sink	$R_{th(j-s)}$							1,18		K/W

Dynamic

Parameter	Symbol	$R_{gon} = 8$ Ω $R_{goff} = 8$ Ω	V_{GS} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max	Unit
Turn-on delay time	$t_{d(on)}$		±15	350	50	25		70		ns
Rise time	t_r					125		70		
						150		71		
						25		45		
Turn-off delay time	$t_{d(off)}$					25		115		
						125		134		
		150		139						
Fall time	t_f			25		22				
Turn-on energy (per pulse)	E_{on}	$Q_{t-FWD} = 1,6$ μC $Q_{t-FWD} = 3,1$ μC $Q_{t-FWD} = 3,6$ μC				25		1,838		mWs
						125		2,198		
						150		2,277		
Turn-off energy (per pulse)	E_{off}					25		0,536		
						125		0,839		
						150		0,941		



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Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V]	I_C [A] I_D [A]	I_C [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Inverter Diode

Static

Forward voltage	V_F				30	25 150		1,64 1,56	1,95	V
Reverse leakage current	I_R			600		25			27	μA

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,63		K/W
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Dynamic

Peak recovery current	I_{RRM}					25 125 150		11 16 17		A
Reverse recovery time	t_{rr}					25 125 150		251 332 393		ns
Recovered charge	Q_r	$di/dt = 245$ A/μs $di/dt = 545$ A/μs $di/dt = 378$ A/μs	±15	350	50	25 125 150		1,615 3,089 3,567		μC
Reverse recovered energy	E_{rec}					25 125 150		0,406 0,762 0,892		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		76 88 101		A/μs



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Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	I_D [A]	T_j [°C]	Min	Typ	Max	

PFC Switch

Static

Parameter	Symbol	Conditions	V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	I_D [A]	T_j [°C]	Min	Typ	Max	Unit
Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$				0,0005	25	3,3	4	4,7	V
Collector-emitter saturation voltage	V_{CEsat}		15			50	25 125 150		1,51 1,65 1,69	2,22	V
Collector-emitter cut-off current	I_{CES}		0	650			25			40	μA
Gate-emitter leakage current	I_{GES}		20	0			25			120	nA
Internal gate resistance	r_g								none		Ω
Input capacitance	C_{ies}								3000		pF
Output capacitance	C_{oes}	$f = 1$ Mhz	0	25		25			50		
Reverse transfer capacitance	C_{res}								11		
Gate charge	Q_g		15	520	50		25		120		nC

Thermal

Parameter	Symbol	Conditions	V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	I_D [A]	T_j [°C]	Min	Typ	Max	Unit
Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)							1,17		K/W

Dynamic

Parameter	Symbol	Conditions	V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	I_D [A]	T_j [°C]	Min	Typ	Max	Unit
Turn-on delay time	$t_{d(on)}$						25 125 150		15 13 15		ns
Rise time	t_r	$R_{gon} = 4 \Omega$ $R_{goff} = 4 \Omega$					25 125 150		6 7 8		
Turn-off delay time	$t_{d(off)}$						25 125 150		82 97 101		
Fall time	t_f						25 125 150		3 6 8		
Turn-on energy (per pulse)	E_{on}	$Q_{t-FWD} = 0,9 \mu C$ $Q_{t-FWD} = 1,8 \mu C$ $Q_{t-FWD} = 2,3 \mu C$					25 125 150		0,429 0,668 0,690		
Turn-off energy (per pulse)	E_{off}						25 125 150		0,152 0,383 0,471		



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Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

PFC Diode

Static

Forward voltage	V_F			50	25 125 150		2,17 1,87 1,80	2,6	V
Reverse leakage current	I_R		650		25			10	μ A

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)					1,14		K/W
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Dynamic

Peak recovery current	I_{RRM}				25 125 150		63 83 92		A
Reverse recovery time	t_{rr}				25 125 150		17 47 54		ns
Recovered charge	Q_r	$di/dt = 6122$ A/ μ s $di/dt = 5344$ A/ μ s $di/dt = 4864$ A/ μ s	0 / 15	400	50	25 125 150	0,941 1,793 2,268		μ C
Reverse recovered energy	E_{rec}					25 125 150	0,212 0,370 0,547		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150	14126 8573 6729		A/ μ s

PFC Sw. Protection Diode

Static

Forward voltage	V_F			10	25 125		1,67 1,56	1,87	V
Reverse leakage current	I_R		650		25			0,14	μ A

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)					2,87		K/W
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Shunt

Resistance	R						1		m Ω
Tolerance*							1		%
Temperature coefficient	tc				20 - 60			75	ppm/K

* Nominal tolerance of the component as shown in manufacturer's datasheet. **Not tested in production**



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Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max		

PFC Shunt

Parameter	Symbol	V_{GS} [V]	V_{DS} [V]	I_D [A]	I_F [A]	T_j [°C]	Min	Typ	Max	Unit
Resistance	R							2		mΩ
Tolerance								1		%
Temperature coefficient	tc					20 - 60			75	ppm/K

* Nominal tolerance of the component as shown in manufacturer's datasheet. **Not tested in production**

Inverter Shunt

Parameter	Symbol	V_{GS} [V]	V_{DS} [V]	I_D [A]	I_F [A]	T_j [°C]	Min	Typ	Max	Unit
Resistance	R							2		mΩ
Tolerance								1		%
Temperature coefficient	tc					20 - 60			75	ppm/K

* Nominal tolerance of the component as shown in manufacturer's datasheet. **Not tested in production**

Capacitor (PFC)

Parameter	Symbol	V_{GS} [V]	V_{DS} [V]	I_D [A]	I_F [A]	T_j [°C]	Min	Typ	Max	Unit
Capacitance	C							33		nF
Tolerance							-5		+5	%

Thermistor

Parameter	Symbol	V_{GS} [V]	V_{DS} [V]	I_D [A]	I_F [A]	T_j [°C]	Min	Typ	Max	Unit
Rated resistance	R					25		22		kΩ
Deviation of R_{100}	$\Delta_{R/R}$					100	-5		5	%
Power dissipation	P					25		5		mW
Power dissipation constant						25		1,5		mW/K
B-value	$B_{(25/50)}$					25		3962		K
B-value	$B_{(25/100)}$					25		4000		K
Vincotech NTC Reference									I	

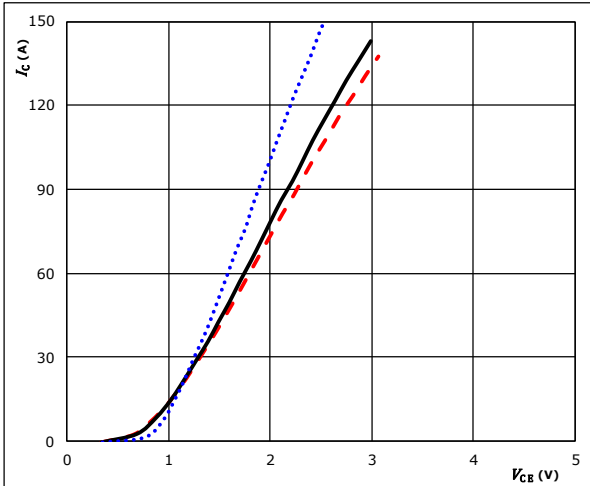


Inverter Switch Characteristics

figure 1. IGBT

Typical output characteristics

$I_C = f(V_{CE})$

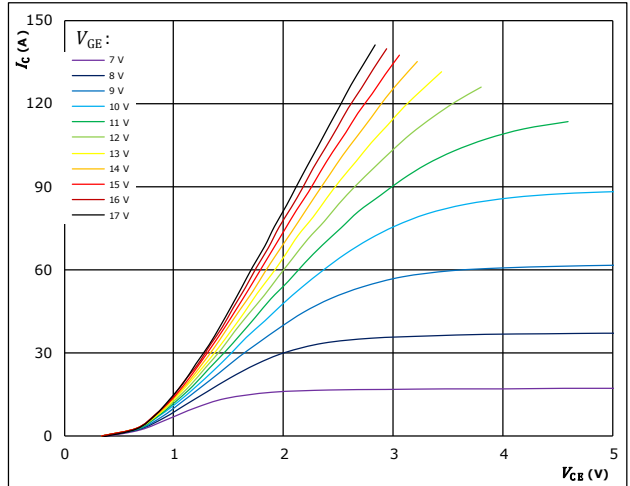


$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_j: 25 \text{ }^\circ C$ (dotted blue line)
 $125 \text{ }^\circ C$ (solid black line)
 $150 \text{ }^\circ C$ (dashed red line)

figure 2. IGBT

Typical output characteristics

$I_C = f(V_{CE})$

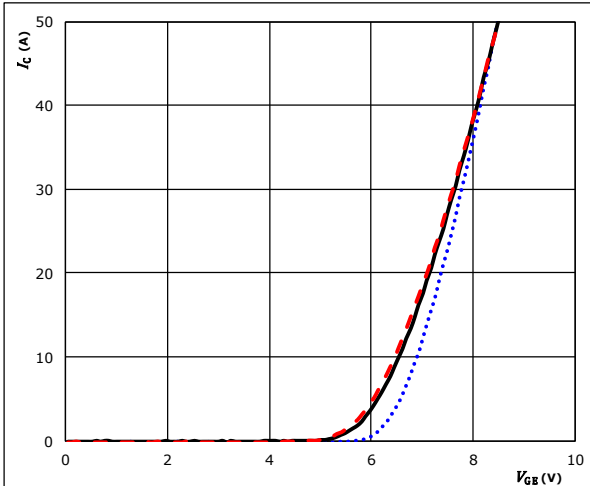


$t_p = 250 \mu s$
 $T_j = 150 \text{ }^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$I_C = f(V_{GE})$

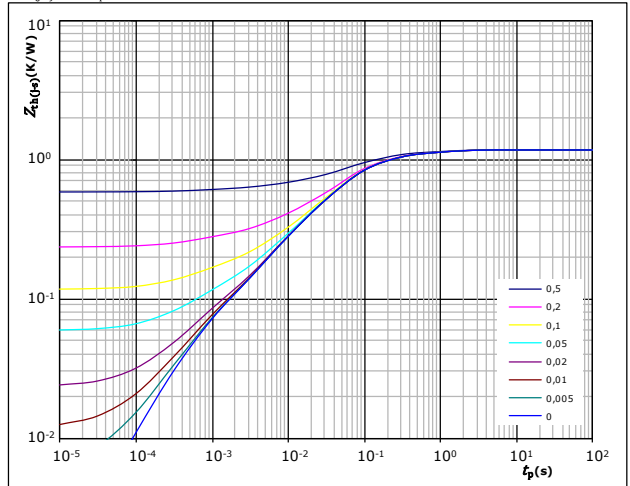


$t_p = 100 \mu s$
 $V_{CE} = 10 V$
 $T_j: 25 \text{ }^\circ C$ (dotted blue line)
 $125 \text{ }^\circ C$ (solid black line)
 $150 \text{ }^\circ C$ (dashed red line)

figure 4. IGBT

Transient thermal impedance as function of pulse duration

$Z_{th(j-s)} = f(t_p)$



$D = t_p / T$
 $R_{th(j-s)} = 1,18 \text{ K/W}$
 IGBT thermal model values

R (K/W)	τ (s)
1,28E-01	9,19E-01
3,00E-01	1,49E-01
5,67E-01	4,76E-02
1,34E-01	6,63E-03
4,70E-02	5,83E-04

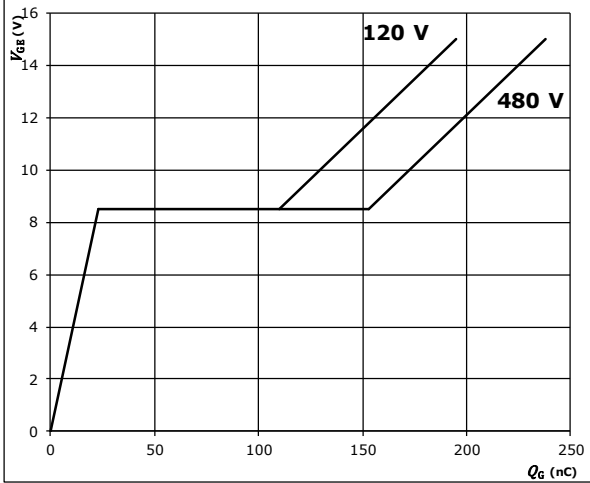


Inverter Switch Characteristics

figure 5. IGBT

Gate voltage vs gate charge

$V_{GE} = f(Q_G)$

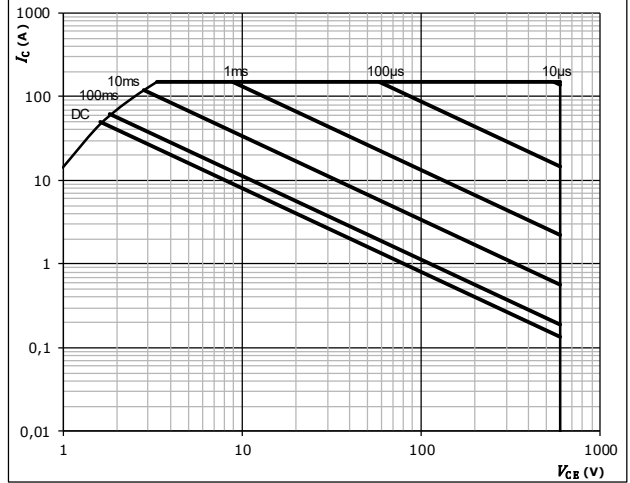


$I_C = 50 \text{ A}$

figure 6. IGBT

Safe operating area

$I_C = f(V_{CE})$



$D =$ single pulse
 $T_s = 80 \text{ }^\circ\text{C}$
 $V_{GE} = \pm 15 \text{ V}$
 $T_j = T_{jmax}$

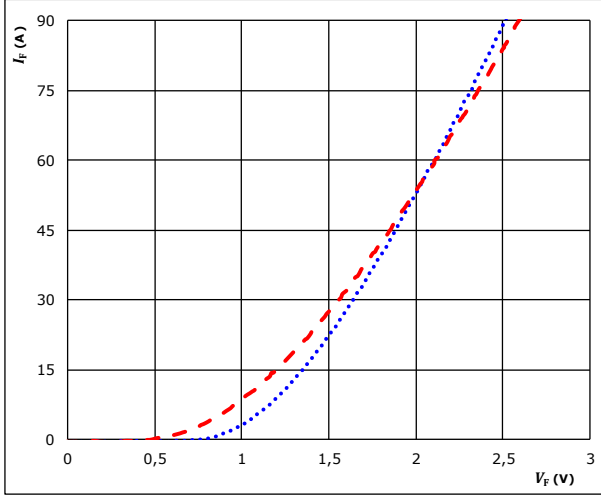


Inverter Diode Characteristics

figure 1. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

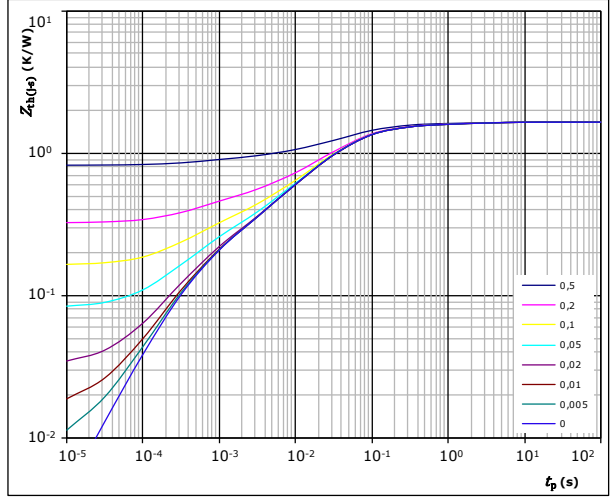


$t_p = 250 \mu s$
 $T_j: 25 \text{ }^\circ\text{C}$
 $150 \text{ }^\circ\text{C}$ - - - - -

figure 2. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,63 \text{ K/W}$

FWD thermal model values

R (K/W)	τ (s)
7,13E-02	2,56E+00
1,55E-01	2,86E-01
7,25E-01	5,21E-02
3,93E-01	1,46E-02
1,57E-01	2,62E-03
1,32E-01	3,83E-04



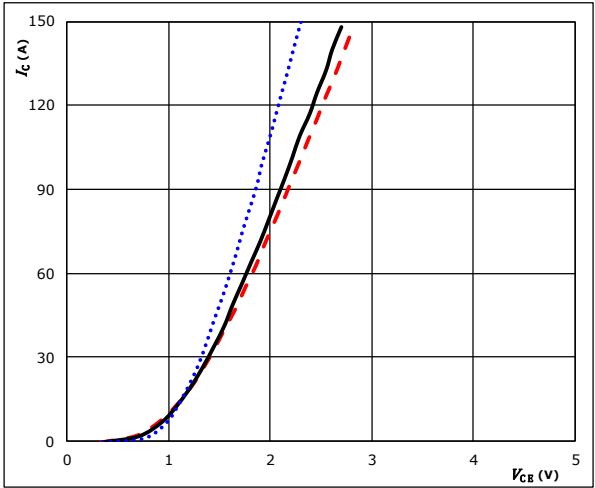
Vincotech

PFC Switch Characteristics

figure 1. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

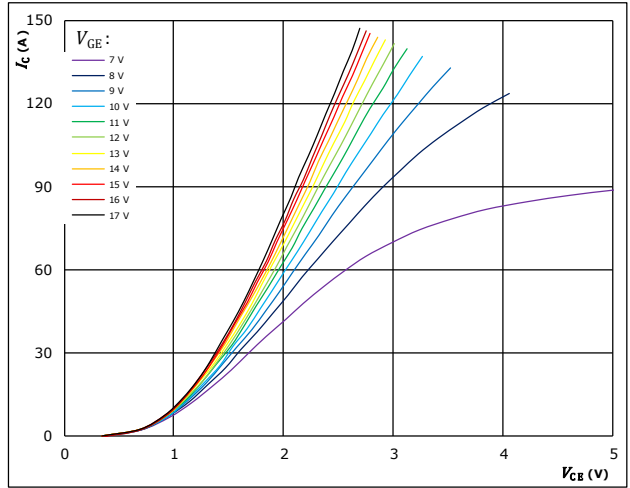


$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_j: 25 \text{ } ^\circ C$ (dotted blue line)
 $125 \text{ } ^\circ C$ (solid black line)
 $150 \text{ } ^\circ C$ (dashed red line)

figure 2. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

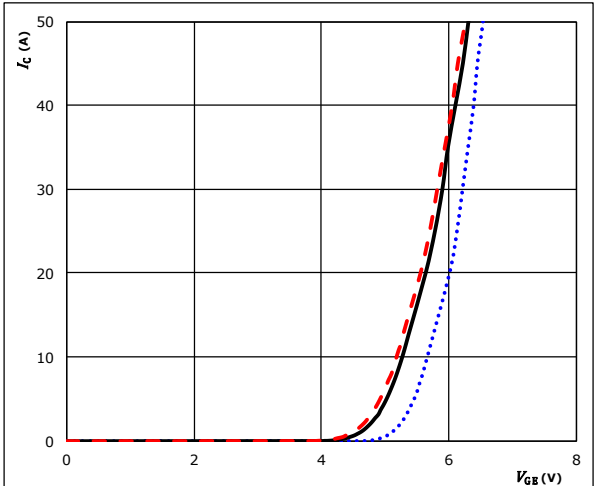


$t_p = 250 \mu s$
 $T_j = 150 \text{ } ^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

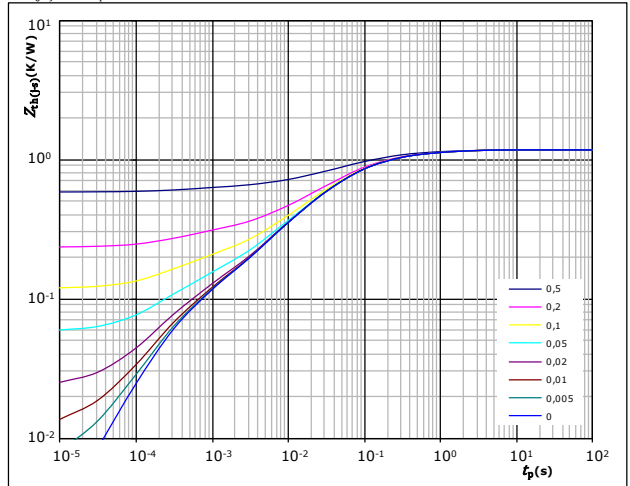


$t_p = 100 \mu s$
 $V_{CE} = 3634 V$
 $T_j: 25 \text{ } ^\circ C$ (dotted blue line)
 $125 \text{ } ^\circ C$ (solid black line)
 $150 \text{ } ^\circ C$ (dashed red line)

figure 4. IGBT

Transient thermal impedance as function of pulse duration

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,17 \text{ K/W}$
 IGBT thermal model values

R (K/W)	τ (s)
9,21E-02	1,46E+00
2,50E-01	2,13E-01
4,87E-01	5,11E-02
2,29E-01	1,02E-02
4,67E-02	1,93E-03
6,92E-02	3,04E-04

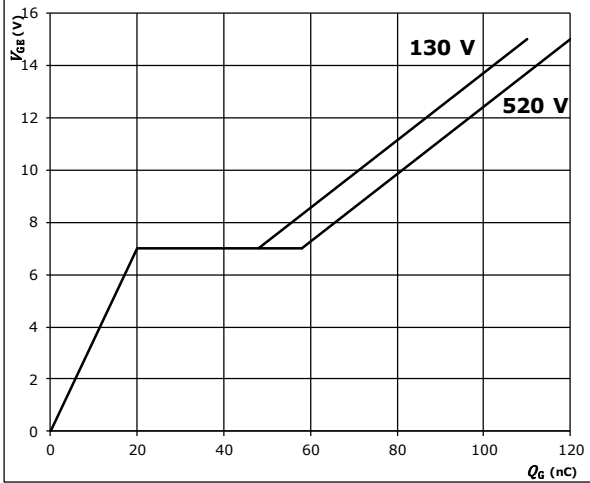


PFC Switch Characteristics

figure 5. IGBT

Gate voltage vs gate charge

$$V_{GE} = f(Q_G)$$

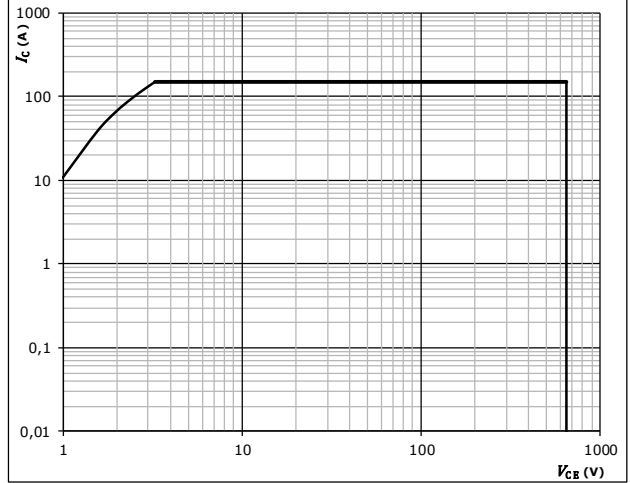


I_C = 50 A

figure 6. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



D = single pulse
T_s = 80 °C
V_{GE} = ±15 V
T_j = T_{jmax}

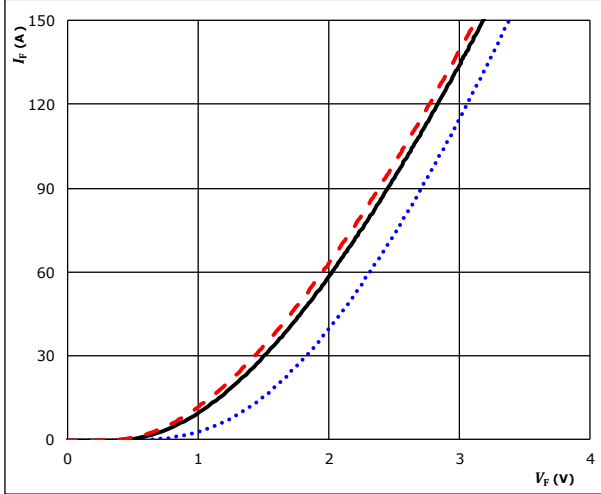


PFC Diode Characteristics

figure 1. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

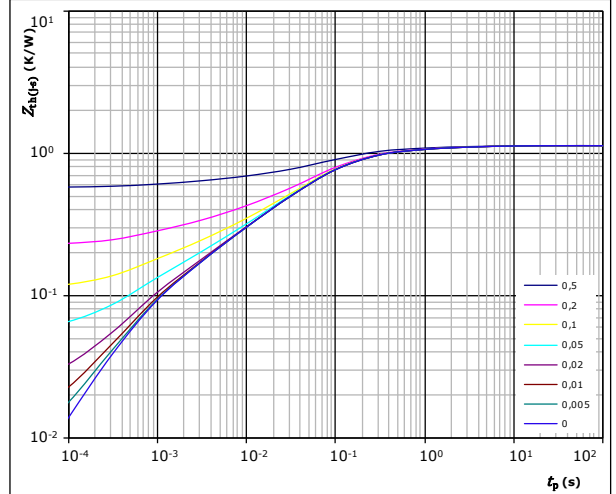


$t_p = 250 \mu s$
 T_j : 25 °C
 125 °C ———
 150 °C - - - -

figure 2. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,14 \text{ K/W}$

FWD thermal model values

R (K/W)	τ (s)
4,89E-02	4,95E+00
1,50E-01	5,95E-01
4,68E-01	1,06E-01
2,69E-01	3,10E-02
1,24E-01	5,12E-03
7,64E-02	7,25E-04

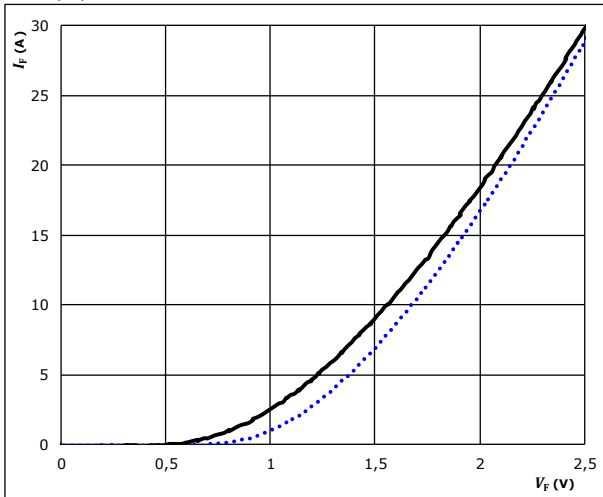


PFC Sw. Protection Diode Characteristics

figure 1. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

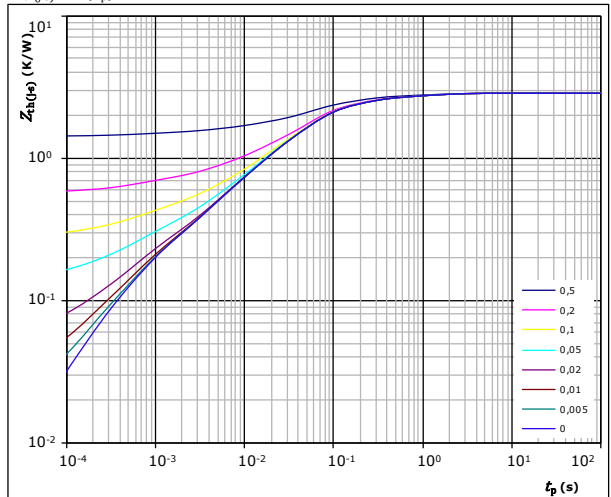


$t_p = 250 \mu s$ $T_j: 25 \text{ }^\circ\text{C}$ (dotted line) $125 \text{ }^\circ\text{C}$ (solid line)

figure 2. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 2,87 \text{ K/W}$
 FWD thermal model values

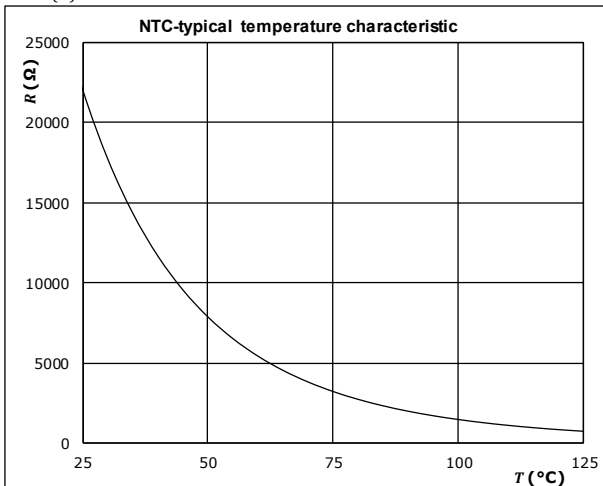
$R \text{ (K/W)}$	$\tau \text{ (s)}$
2,86E-01	2,80E+00
5,75E-01	4,47E-01
1,57E+00	1,18E-01
3,05E-01	1,46E-02
1,34E-01	1,45E-03

Thermistor Characteristics

figure 1. Thermistor

Typical NTC characteristic as a function of temperature

$$R = f(T)$$



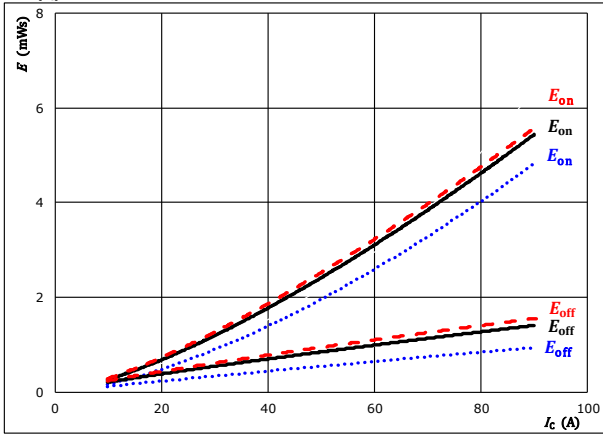


Inverter Switching Characteristics

figure 1. IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_C)$$

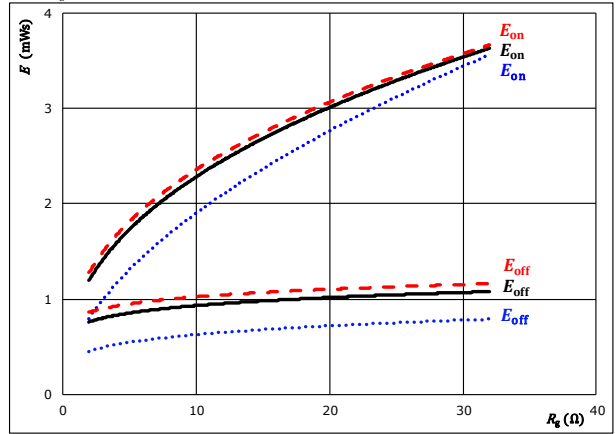


With an inductive load at
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{g\text{on}} = 8$ Ω
 $R_{g\text{off}} = 8$ Ω
 $T_j: 25$ °C (dotted blue)
 125 °C (solid black)
 125 °C (dashed red)

figure 2. IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$

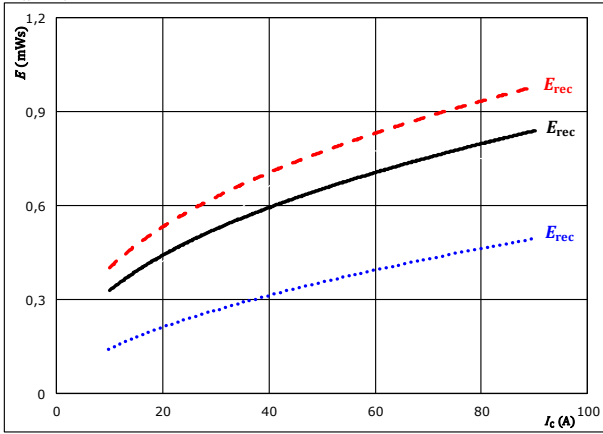


With an inductive load at
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_C = 50$ A
 $T_j: 25$ °C (dotted blue)
 125 °C (solid black)
 125 °C (dashed red)

figure 3. FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_C)$$

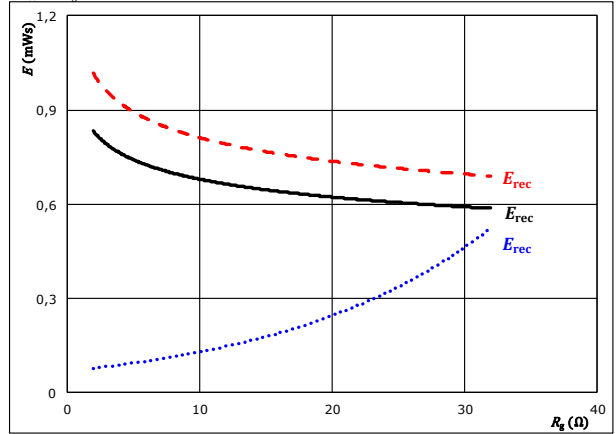


With an inductive load at
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{g\text{on}} = 8$ Ω
 $T_j: 25$ °C (dotted blue)
 125 °C (solid black)
 125 °C (dashed red)

figure 4. FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_C = 50$ A
 $T_j: 25$ °C (dotted blue)
 125 °C (solid black)
 125 °C (dashed red)

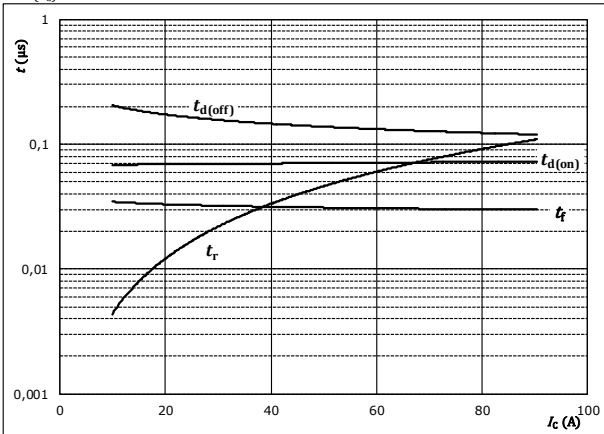


Inverter Switching Characteristics

figure 5. IGBT

Typical switching times as a function of collector current

$$t = f(I_C)$$



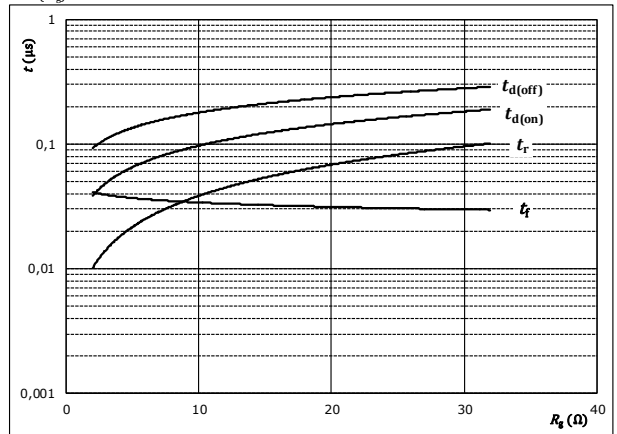
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	350	V
$V_{GE} =$	±15	V
$R_{g(on)} =$	8	Ω
$R_{g(off)} =$	8	Ω

figure 6. IGBT

Typical switching times as a function of gate resistor

$$t = f(R_g)$$



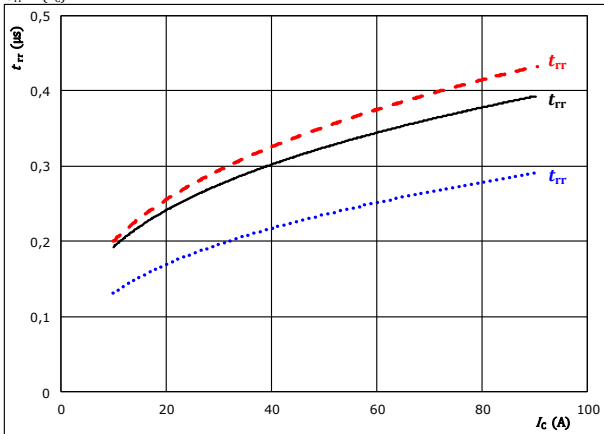
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	350	V
$V_{GE} =$	±15	V
$I_C =$	50	A

figure 7. FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$



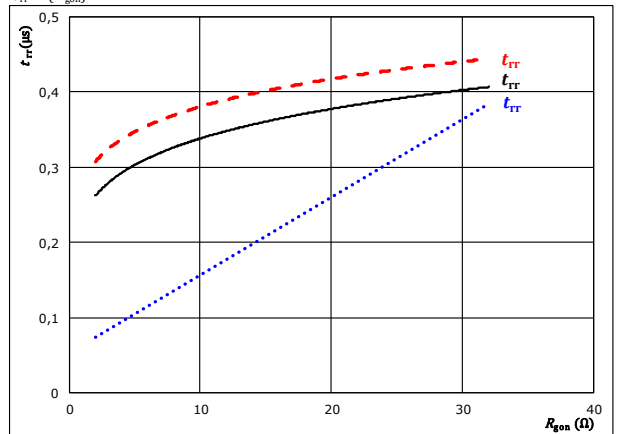
With an inductive load at

$V_{CE} =$	350	V	$T_j:$	25 °C
$V_{GE} =$	±15	V		125 °C	————
$R_{g(on)} =$	8	Ω		125 °C	- - - -

figure 8. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{g(on)})$$



With an inductive load at

$V_{CE} =$	350	V	$T_j:$	25 °C
$V_{GE} =$	±15	V		125 °C	————
$I_C =$	50	A		125 °C	- - - -

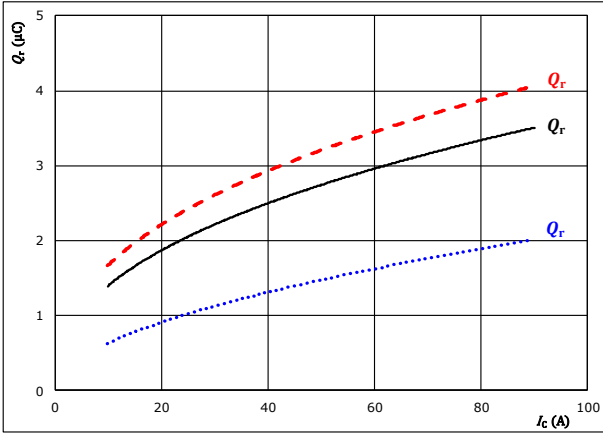


Inverter Switching Characteristics

figure 9. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$

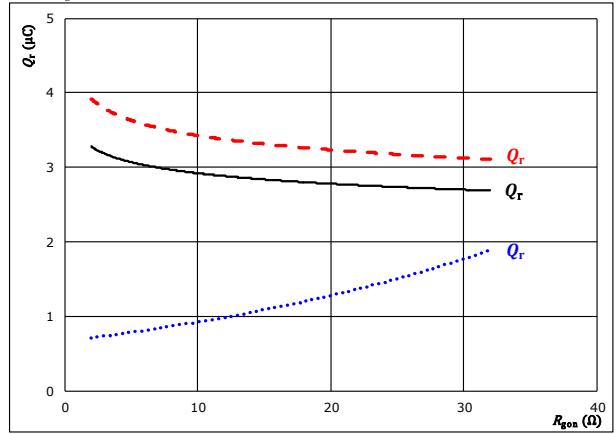


With an inductive load at
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gpn} = 8$ Ω
 $T_j: 25^\circ\text{C}$ (blue dotted)
 125°C (black solid)
 125°C (red dashed)

figure 10. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gpn})$$

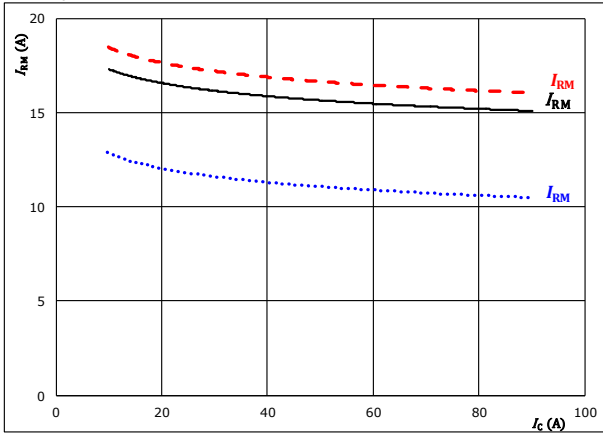


With an inductive load at
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 50$ A
 $T_j: 25^\circ\text{C}$ (blue dotted)
 125°C (black solid)
 125°C (red dashed)

figure 11. FWD

Typical peak reverse recovery current current as a function of collector current

$$I_{RM} = f(I_c)$$

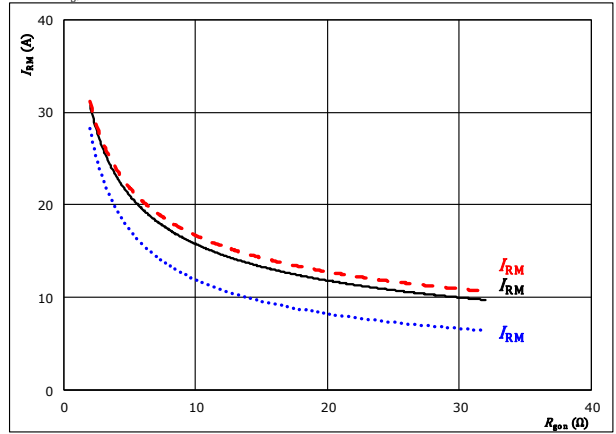


With an inductive load at
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gpn} = 8$ Ω
 $T_j: 25^\circ\text{C}$ (blue dotted)
 125°C (black solid)
 125°C (red dashed)

figure 12. FWD

Typical peak reverse recovery current current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gpn})$$



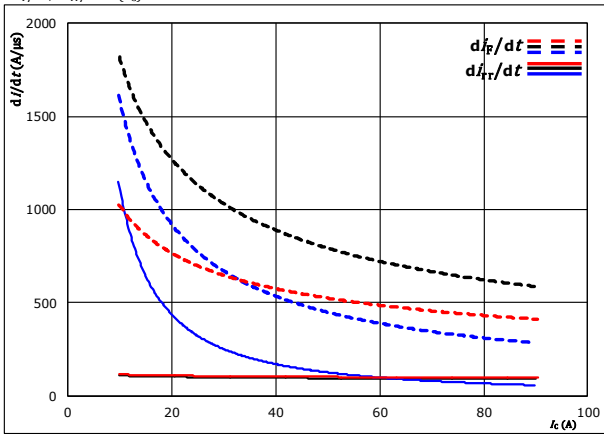
With an inductive load at
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 50$ A
 $T_j: 25^\circ\text{C}$ (blue dotted)
 125°C (black solid)
 125°C (red dashed)



Inverter Switching Characteristics

figure 13. FWD

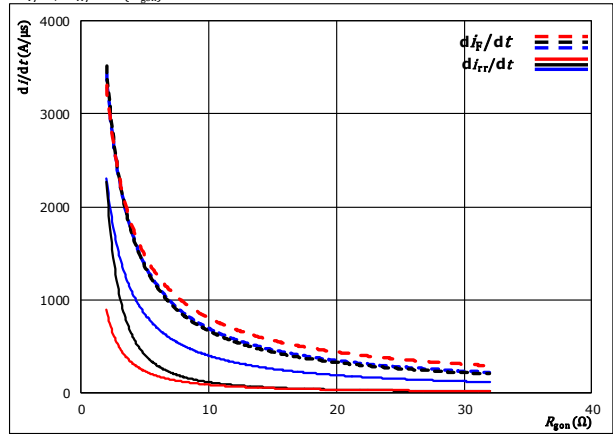
Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_{f}/dt, di_{rr}/dt = f(I_C)$



With an inductive load at
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 8 \text{ } \Omega$
 $T_j = 25 \text{ } ^\circ\text{C}$
 $125 \text{ } ^\circ\text{C}$
 $125 \text{ } ^\circ\text{C}$

figure 14. FWD

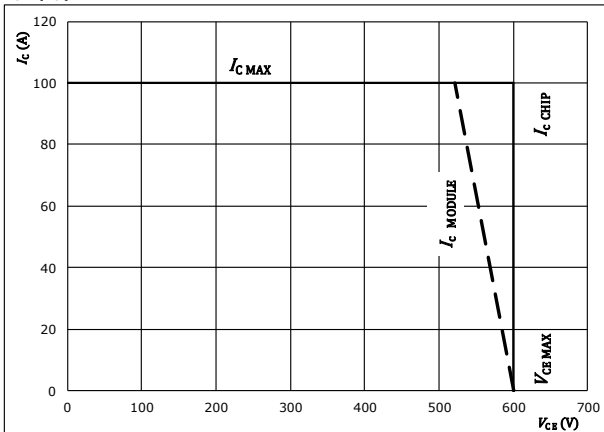
Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor
 $di_{f}/dt, di_{rr}/dt = f(R_{gon})$



With an inductive load at
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 50 \text{ A}$
 $T_j = 25 \text{ } ^\circ\text{C}$
 $125 \text{ } ^\circ\text{C}$
 $125 \text{ } ^\circ\text{C}$

figure 15. IGBT

Reverse bias safe operating area
 $I_C = f(V_{CB})$



At
 $T_j = 125 \text{ } ^\circ\text{C}$
 $R_{gon} = 8 \text{ } \Omega$
 $R_{goff} = 8 \text{ } \Omega$

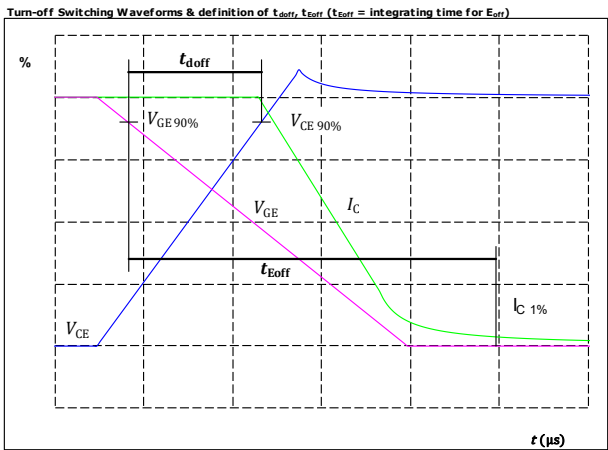


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Inverter Switching Definitions

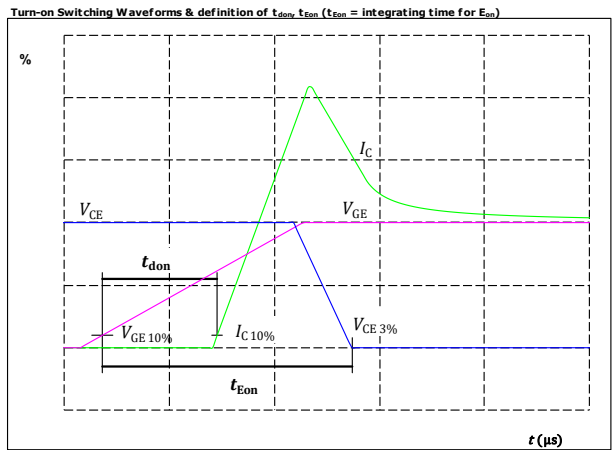
General conditions		
T_j	=	125 °C
R_{gon}	=	8 Ω
R_{goff}	=	8 Ω

figure 1. IGBT



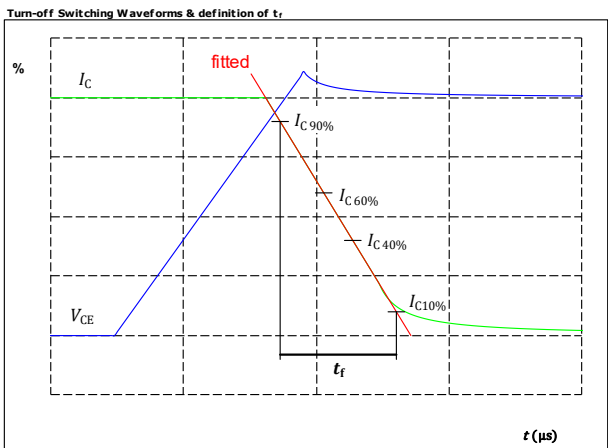
$V_{CE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	350	V
$I_C(100\%) =$	50	A
$t_{doff} =$	134	ns

figure 2. IGBT



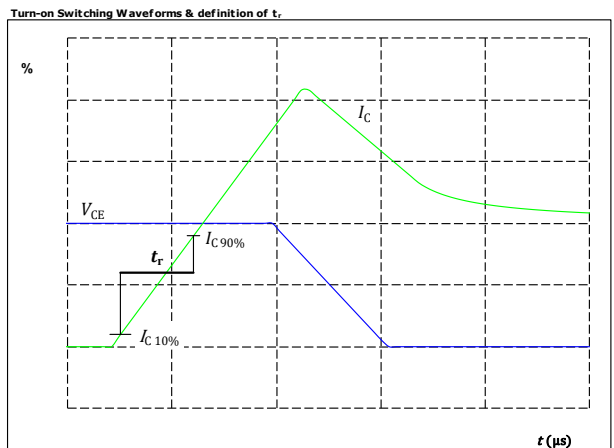
$V_{CE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	350	V
$I_C(100\%) =$	50	A
$t_{don} =$	70	ns

figure 3. IGBT



$V_C(100\%) =$	350	V
$I_C(100\%) =$	50	A
$t_r =$	34	ns

figure 4. IGBT



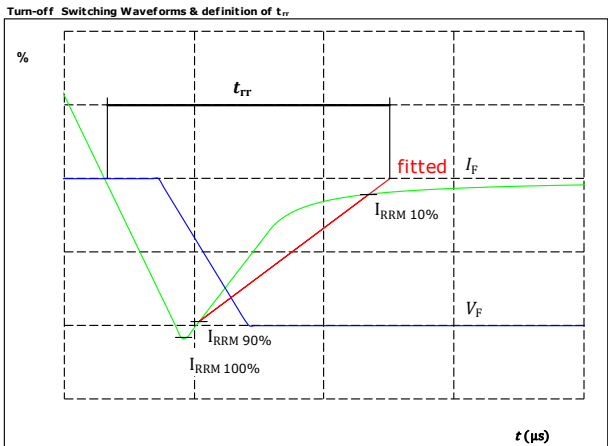
$V_C(100\%) =$	350	V
$I_C(100\%) =$	50	A
$t_r =$	43	ns



Vincotech

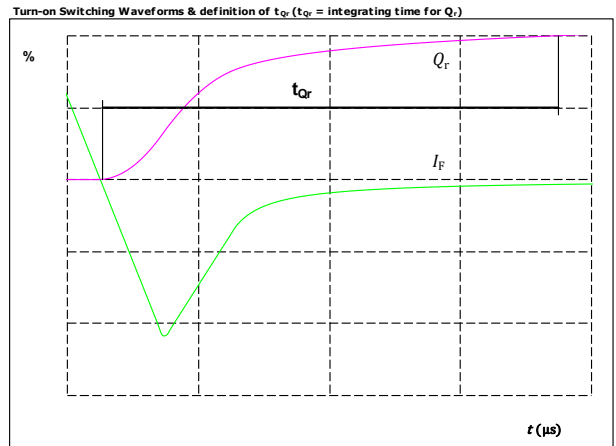
Inverter Switching Characteristics

figure 5. FWD



$V_F(100\%) =$	350	V
$I_F(100\%) =$	50	A
$I_{RRM}(100\%) =$	16	A
$t_{rr} =$	332	ns

figure 6. FWD

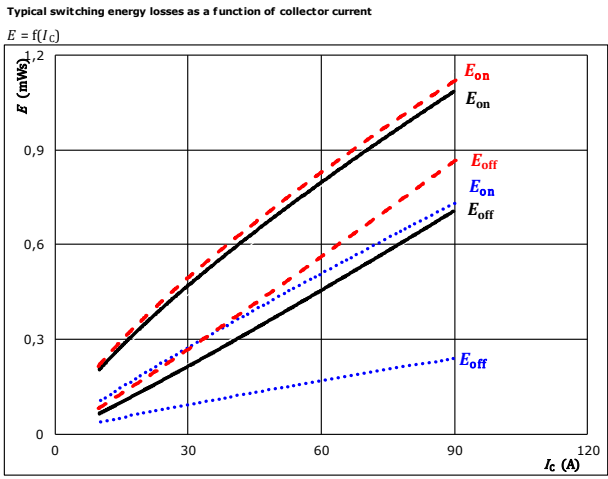


$I_F(100\%) =$	50	A
$Q_r(100\%) =$	3,09	μC



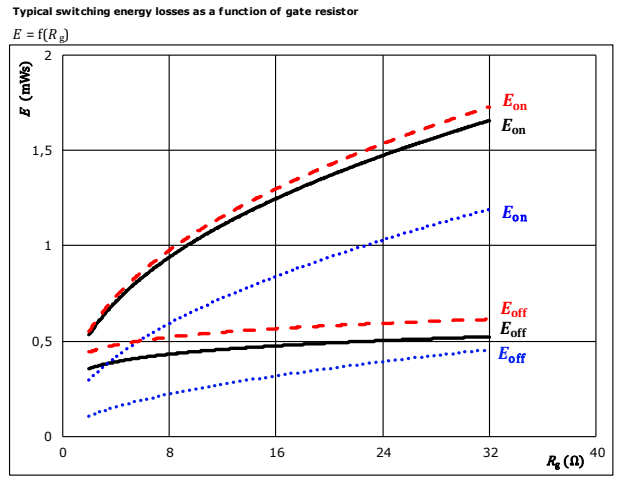
PFC Switching Characteristics

figure 1. IGBT



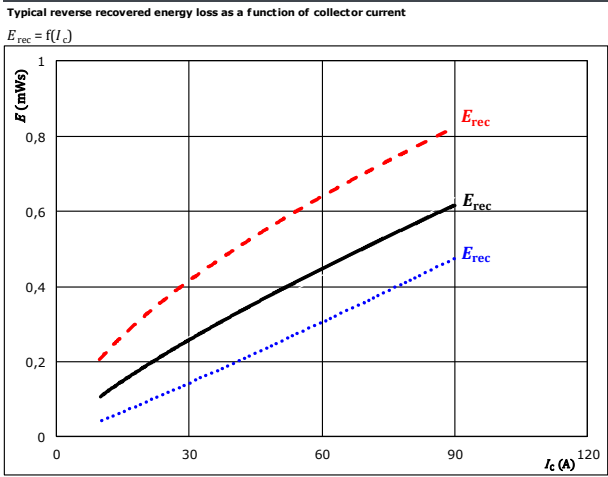
With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0 / 15$ V
 $R_{g\text{on}} = 4$ Ω
 $R_{g\text{off}} = 4$ Ω
 $T_j: 25$ °C
 125 °C
 150 °C

figure 2. IGBT



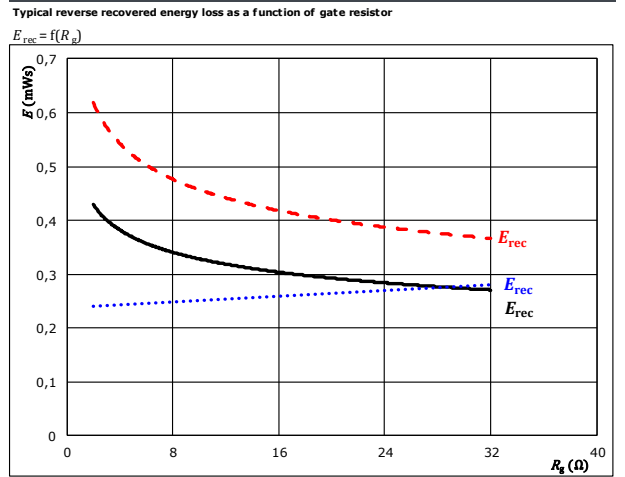
With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0 / 15$ V
 $I_c = 50$ A
 $T_j: 25$ °C
 125 °C
 150 °C

figure 3. FWD



With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0 / 15$ V
 $R_{g\text{on}} = 4$ Ω
 $T_j: 25$ °C
 125 °C
 150 °C

figure 4. FWD



With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0 / 15$ V
 $I_c = 50$ A
 $T_j: 25$ °C
 125 °C
 150 °C

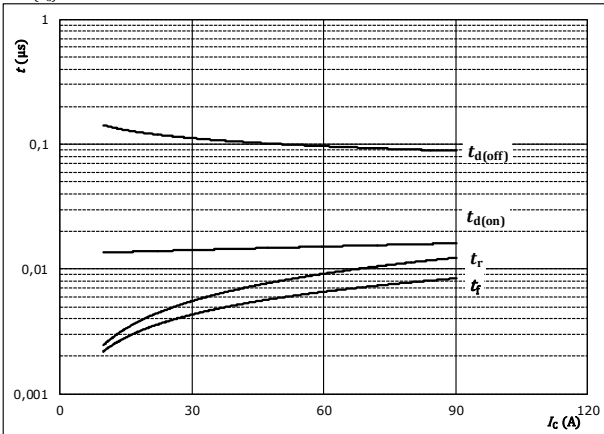


PFC Switching Characteristics

figure 5. IGBT

Typical switching times as a function of collector current

$$t = f(I_C)$$



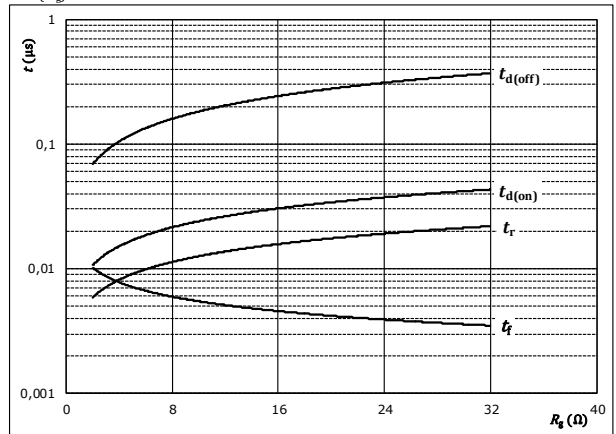
With an inductive load at

- $T_j = 150$ °C
- $V_{CE} = 400$ V
- $V_{GE} = 0 / 15$ V
- $R_{gon} = 4$ Ω
- $R_{goff} = 4$ Ω

figure 6. IGBT

Typical switching times as a function of gate resistor

$$t = f(R_g)$$



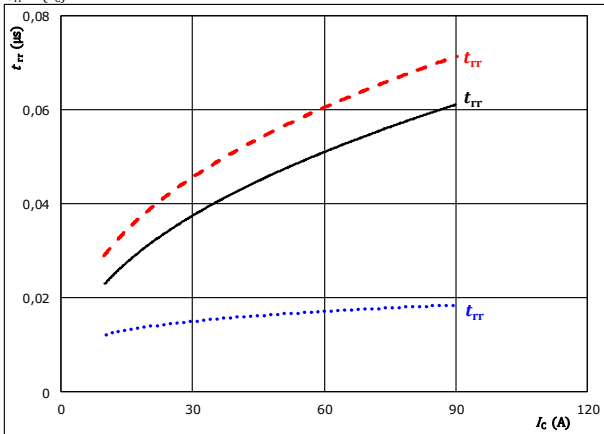
With an inductive load at

- $T_j = 150$ °C
- $V_{CE} = 400$ V
- $V_{GE} = 0 / 15$ V
- $I_C = 50$ A

figure 7. FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$



With an inductive load at

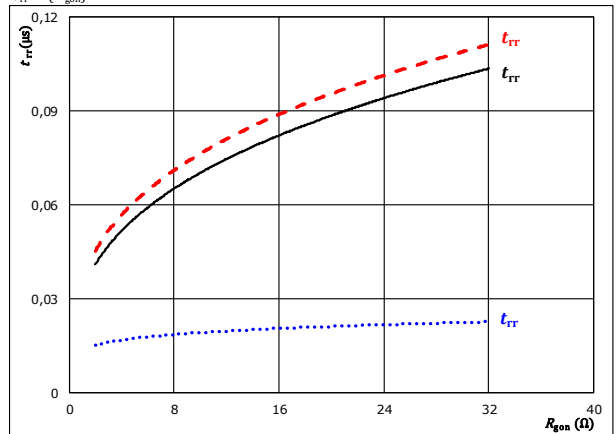
- $V_{CE} = 400$ V
- $V_{GE} = 0 / 15$ V
- $R_{gon} = 4$ Ω

- $T_j: 25$ °C (dotted blue)
- 125 °C (solid black)
- 150 °C (dashed red)

figure 8. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$



With an inductive load at

- $V_{CE} = 400$ V
- $V_{GE} = 0 / 15$ V
- $I_C = 50$ A

- $T_j: 25$ °C (dotted blue)
- 125 °C (solid black)
- 150 °C (dashed red)

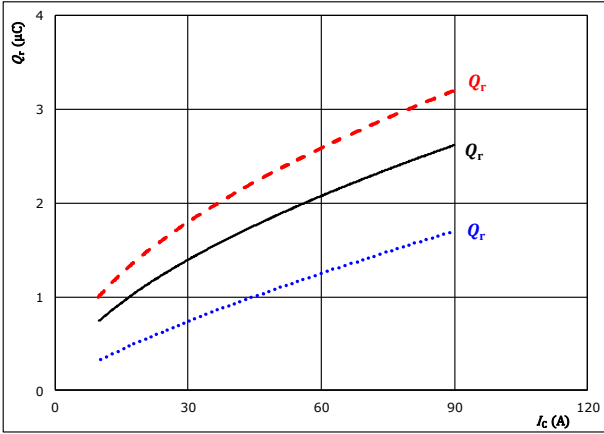


PFC Switching Characteristics

figure 9. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$

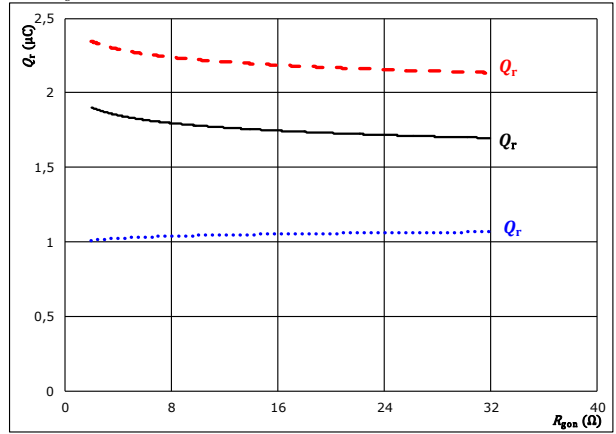


With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0 / 15$ V
 $R_{ggn} = 4$ Ω
 $T_j: 25$ °C (blue dotted)
 125 °C (black solid)
 150 °C (red dashed)

figure 10. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{ggn})$$

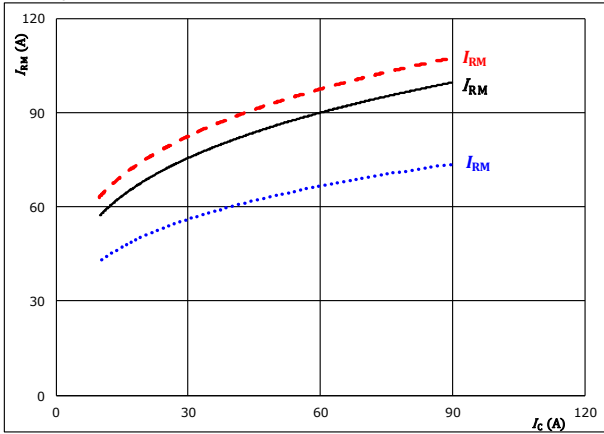


With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0 / 15$ V
 $I_c = 50$ A
 $T_j: 25$ °C (blue dotted)
 125 °C (black solid)
 150 °C (red dashed)

figure 11. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$

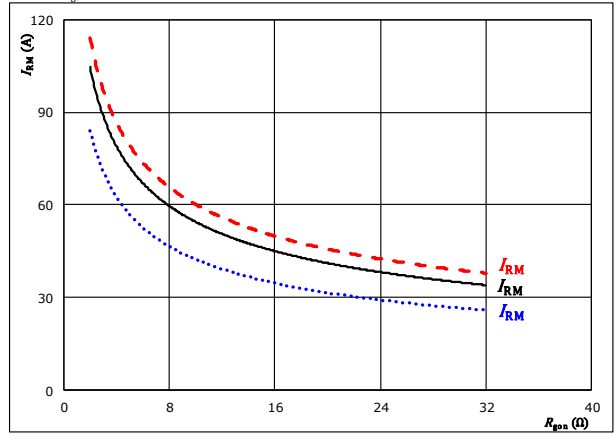


With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0 / 15$ V
 $R_{ggn} = 4$ Ω
 $T_j: 25$ °C (blue dotted)
 125 °C (black solid)
 150 °C (red dashed)

figure 12. FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{ggn})$$



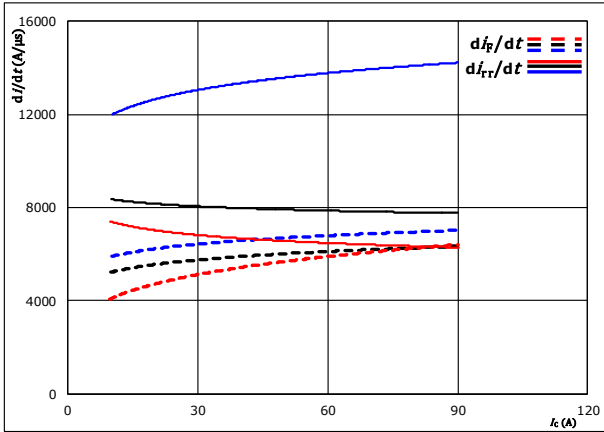
With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0 / 15$ V
 $I_c = 50$ A
 $T_j: 25$ °C (blue dotted)
 125 °C (black solid)
 150 °C (red dashed)



PFC Switching Characteristics

figure 13. FWD

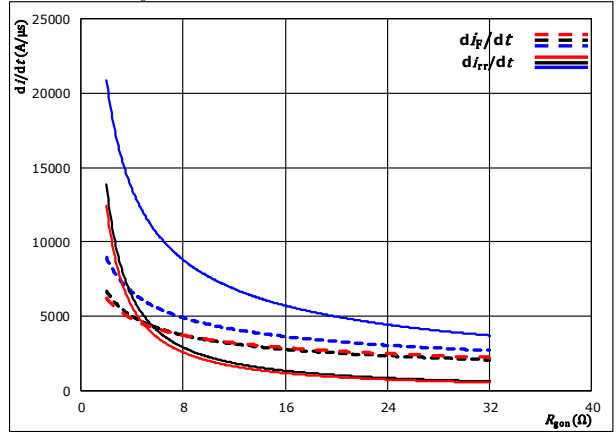
Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$



With an inductive load at
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0 / 15 \text{ V}$
 $R_{gon} = 4 \text{ } \Omega$
 $T_j = 25 \text{ } ^\circ\text{C}$
 $150 \text{ } ^\circ\text{C}$

figure 14. FWD

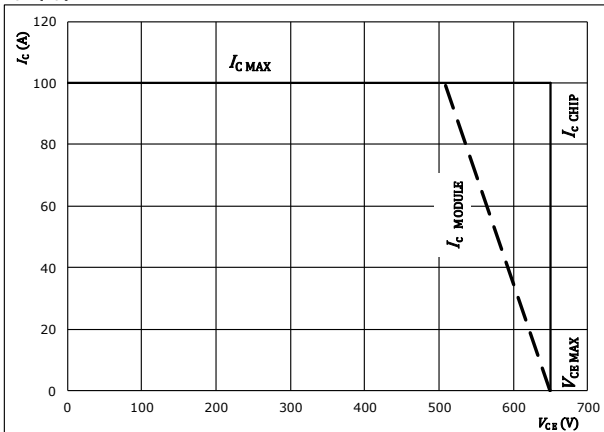
Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$



With an inductive load at
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0 / 15 \text{ V}$
 $I_c = 50 \text{ A}$
 $T_j = 25 \text{ } ^\circ\text{C}$
 $150 \text{ } ^\circ\text{C}$

figure 15. IGBT

Reverse bias safe operating area
 $I_c = f(V_{CE})$



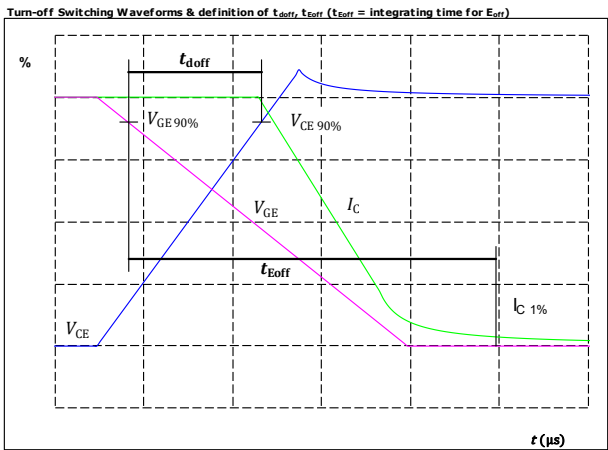
At
 $T_j = 125 \text{ } ^\circ\text{C}$
 $R_{gon} = 4 \text{ } \Omega$
 $R_{goff} = 4 \text{ } \Omega$



PFC Switching Definitions

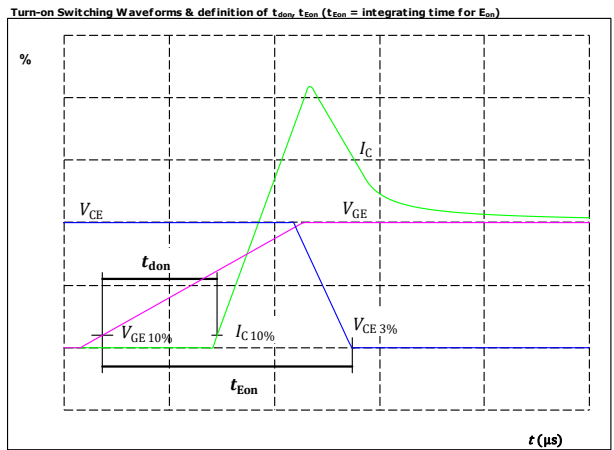
General conditions		
T_j	=	125 °C
R_{gon}	=	4 Ω
R_{goff}	=	4 Ω

figure 1. IGBT



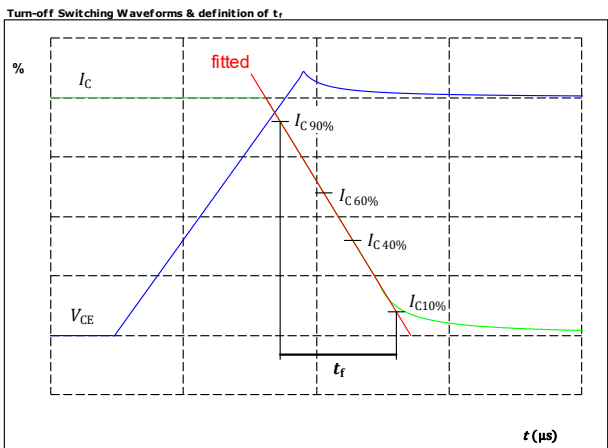
$V_{CE}(0\%) =$	0	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	400	V
$I_C(100\%) =$	50	A
$t_{doff} =$	97	ns

figure 2. IGBT



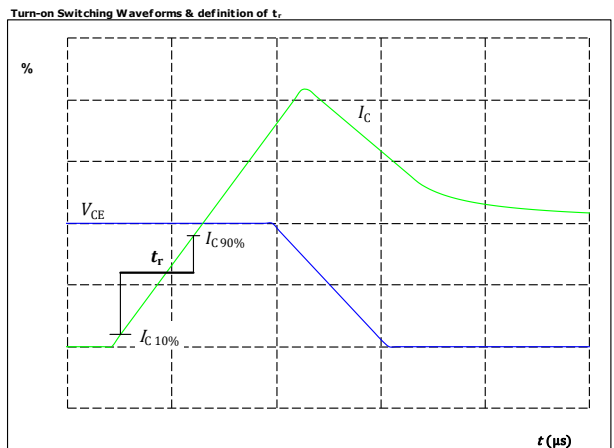
$V_{CE}(0\%) =$	0	V
$V_{CE}(100\%) =$	15	V
$V_C(100\%) =$	400	V
$I_C(100\%) =$	50	A
$t_{don} =$	13	ns

figure 3. IGBT



$V_C(100\%) =$	400	V
$I_C(100\%) =$	50	A
$t_f =$	6	ns

figure 4. IGBT



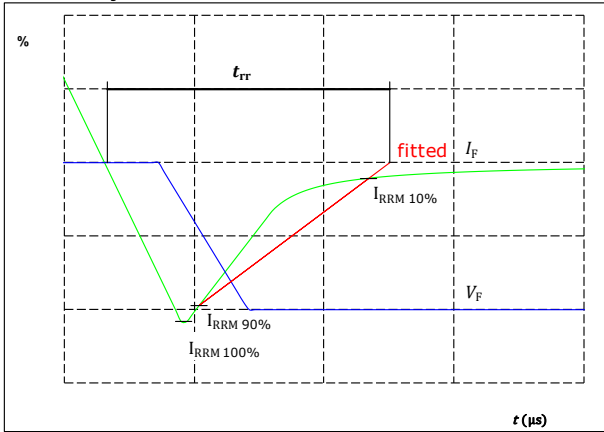
$V_C(100\%) =$	400	V
$I_C(100\%) =$	50	A
$t_r =$	7	ns



Vincotech

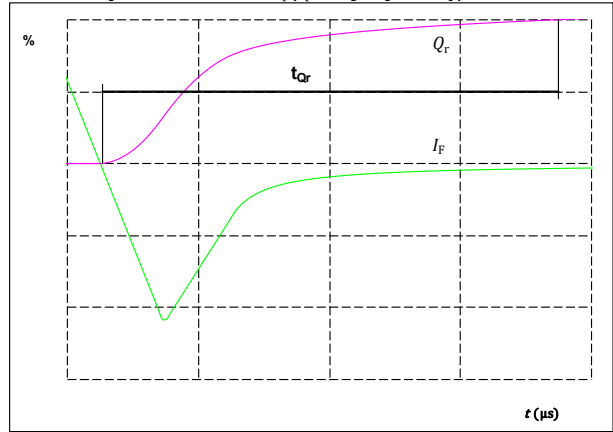
PFC Switching Characteristics

figure 5. FWD
Turn-off Switching Waveforms & definition of t_{rr}



$V_F(100\%) =$	400	V
$I_F(100\%) =$	50	A
$I_{RRM}(100\%) =$	83	A
$t_{rr} =$	47	ns

figure 6. FWD
Turn-on Switching Waveforms & definition of t_{Qr} ($t_{Qr} =$ integrating time for Q_r)



$I_F(100\%) =$	50	A
$Q_r(100\%) =$	1,79	μC



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Ordering Code & Marking								
Version			Ordering Code					
without thermal paste 12mm housing with Press-fit pins			10-PG06PPA050SJ01-LH54E08T					
with thermal paste 12mm housing with Press-fit pins			10-PG06PPA050SJ01-LH54E08T-/3/					
NN-NNNNNNNNNNNN TTTTWW WWYY UL VIN LLLL SSSS			Text	Name	Date code	UL & VIN	Lot	Serial
				NN-NNNNNNNNNNNN-TTTTWW	WWYY	UL VIN	LLLL	SSSS
			Datamatrix	Type&Ver	Lot number	Serial	Date code	
			TTTTTWW	LLLL	SSSS	WWYY		

Pin table			
Pin	X	Y	Function
1	52,5	2,7	DC+Inv
2	52,5	0	DC+Inv
3	46,2	0	Ph3
4	43,5	0	Ph3
5	43,5	3	G16
6	37,2	0	Ph2
7	34,5	0	Ph2
8	34,5	3	G14
9	28,2	0	Ph1
10	25,5	0	Ph1
11	22,5	0	G12
12	0	0	PFC1
13	0	6,1	PFC2
14	19,5	6,6	S25
15	22,5	6,6	G25
16	25,5	8,3	S1sh2
17	25,5	11,3	S2sh2
18	0	16,8	DC-Rect
19	0	19,5	DC-Rect
20	0	22,5	S2sh1
21	0	25,5	S1sh1
22	0	28,5	DC-SH
23	2,7	28,5	DC-SH
24	9,8	25,8	PFC+
25	9,8	28,5	PFC+
26	20,7	16,5	S27
27	20,7	19,5	G27
28	16,9	23,5	S1sh3
29	16,9	26,5	S2sh3
30	20,7	28,5	PFC-
31	23,4	28,5	PFC-
32	22	25,5	Therm1
33	22	22,5	Therm2
34	27	28,5	DC-1
35	33,5	28,5	S2sh4
36	33,5	25,5	S1sh4
37	33,5	22,5	G11
38	36,5	28,5	DC-2
39	43	28,5	S2sh5
40	43	25,5	S1sh5
41	43	22,5	G13
42	46	28,5	DC-3
43	52,5	28,5	S2sh6
44	52,5	25,5	S1sh6
45	52,5	22,5	G15
46	Not assembled		

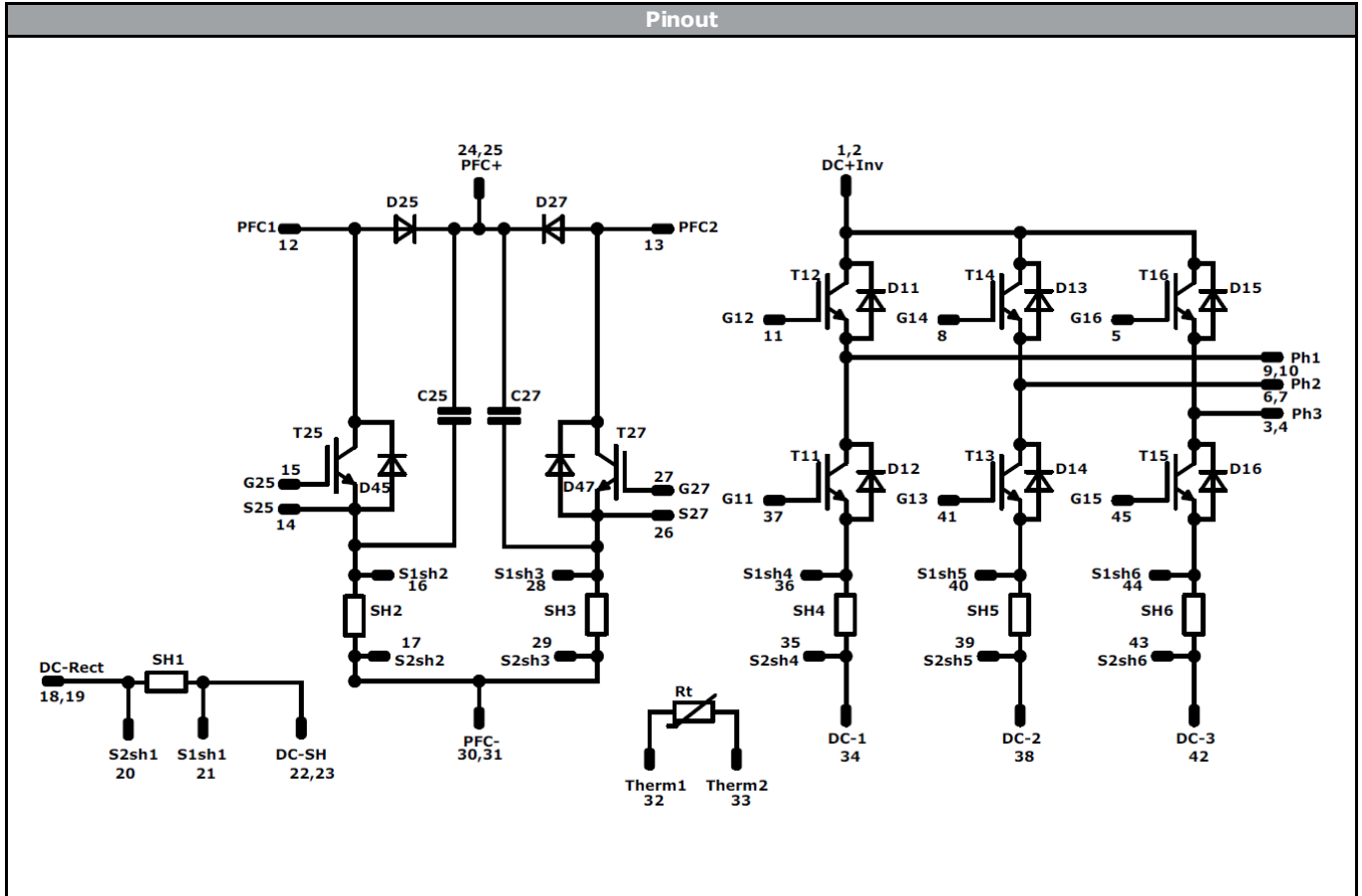
Outline

center of press-fit pinhead
for connection parameter see the handling instruction

Tolerance of pinpositions: ±0,4mm at the end of pins
Dimension of coordinate axis is only offset without tolerance



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Identification					
ID	Component	Voltage	Current	Function	Comment
T11, T12, T13, T14, T15, T16	IGBT	600 V	50 A	Inverter Switch	
D11, D12, D13, D14, D15, D16	FWD	600 V	30 A	Inverter Diode	
T25, T27	IGBT	650 V	50 A	PFC Switch	
D25, D27	FWD	650 V	50 A	PFC Diode	
D45, D47	FWD	650 V	10 A	PFC Sw. Protection Diode	
SH1	Shunt		63 A	Shunt	
SH2, SH3	Shunt		32 A	PFC Shunt	
SH4, SH5, SH6	Shunt		32 A	Inverter Shunt	
C25, C27	Capacitor	630 V		Capacitor (PFC)	
Rt	NTC			Thermistor	




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Packaging instruction			
Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ Sample

Handling instruction
Handling instructions for <i>flow 1</i> packages see vincotech.com website.

Package data
Package data for <i>flow 1</i> packages see vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
10-PG06PPA050SJ01-LH54E08T-D3-14	09 May. 2019	Correction of I _c /I _f values	2

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